

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2048	(313/292,496).CCLS.	US-PGPUB; USPAT	OR	OFF	2009/05/05 15:03
S51	1	("6517399").PN.	US-PGPUB; USPAT	OR	OFF	2009/05/04 16:18
S50	27	((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer and ((electron field) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:28
S49	0	((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer and ((electron field) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:28
S48	789	((conductive adj adhesive) with (solder (Low adj melting adj point adj metal))) and spacer	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:27
S47	6653	((conductive adj adhesive) with (solder (Low adj melting adj point adj metal)))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:27
S46	41	((conductive adj adhesive) with (Low adj melting adj point adj metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:22
S45	41	((conductive adj adhesive) with (Low adj melting adj point adj metal))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:21
S44	0	((conductive adj adhesive) with (Low adj melting adj point adj metal)) and ((electron field surface) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:21

S43	0	((conductive adj adhesive) with (Low adj melting adj point adj metal))and ((electron field surface) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:21
S42	5	(spacer with (conductive adj adhesive)) and ((electron field surface) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:20
S41	15	(spacer with tin) and ((electron field surface) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:17
S40	5	(spacer with solder) and ((electron field surface) adj (emission emitter)).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/05/04 15:15
S39	1	("7078854").PN.	US-PGPUB; USPAT	OR	OFF	2009/05/04 15:13
S38	1	("20040075378").PN.	US-PGPUB; USPAT	OR	OFF	2009/05/04 15:11
S37	1	("20040075378").PN.	US-PGPUB; USPAT	OR	OFF	2009/04/21 16:28
S36	27	spacer with (low adj melting adj metal)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/04/21 16:24
S35	24	spacer and bonding with (low adj melting adj metal)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/04/21 16:14
S34	1	("6884138").PN.	US-PGPUB; USPAT	OR	OFF	2009/04/21 16:10
S33	1	("20070138937").PN.	US-PGPUB; USPAT	OR	OFF	2009/04/20 17:09
S32	15	(gold adj palladium adj alloy) with (melting adj point)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/04/20 15:15
S31	155	(gold adj alloy) with (melting adj point)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/04/20 14:20
S30	0	(gold adj alloy) with paladium with (melting adj point)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2009/04/20 14:20

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